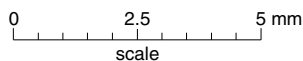
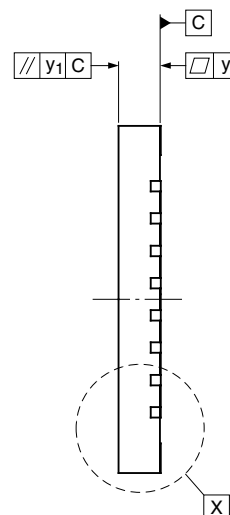
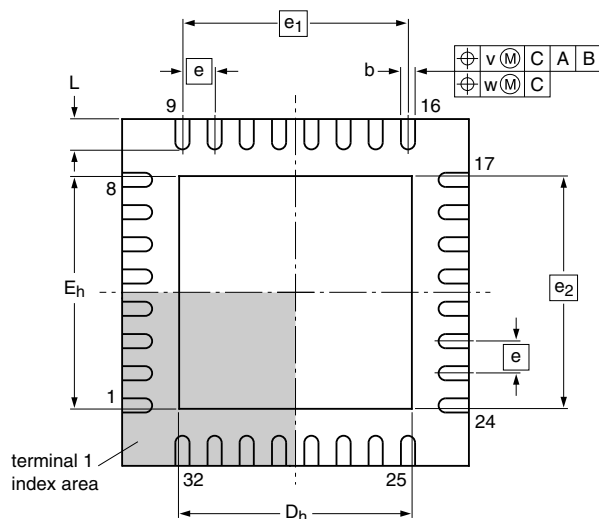
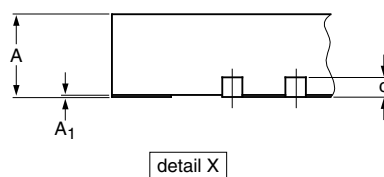
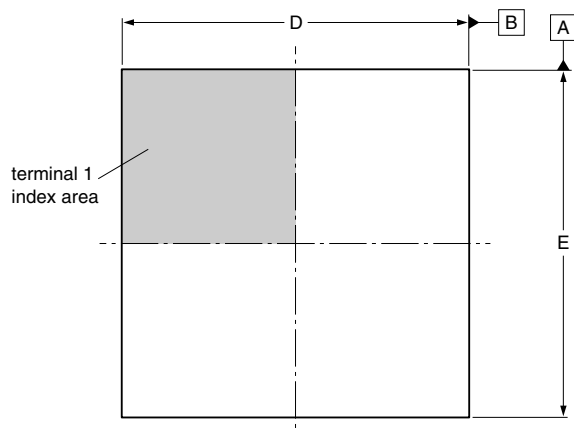


HVQFN32: plastic thermal enhanced very thin quad flat package; no leads;
32 terminals; body 7 x 7 x 0.85 mm

SOT865-3



Dimensions

Unit ⁽¹⁾	A	A ₁	b	c	D	D _h	E	E _h	e	e ₁	e ₂	L	v	w	y	y ₁
max	1.00	0.05	0.35		7.1	4.85	7.1	4.85				0.75				
mm nom	0.85	0.02	0.28	0.2	7.0	4.70	7.0	4.70	0.65	4.55	4.55	0.60	0.1	0.05	0.08	0.1
min	0.80	0.00	0.23		6.9	4.55	6.9	4.55				0.45				

Note

1. Plastic or metal protrusions of 0.075 mm maximum per side are not included

sot865-3_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT865-3		MO-220				09-01-09 09-02-05